

4-Channel Low-Phase-Noise Low-Power Continuous Wave Transmitter

Features

- · Low Phase Noise
- · 100V Open Drain N-channel
- · High-speed D Flip-flop
- · High-speed MOSFET Gate Driver
- · Up to 200 MHz Clock Input
- V_{DD} and V_{LL} Undervoltage Lockout

Applications

- · Diagnostic Medical Ultrasound
- · Fluid Flow Measurement

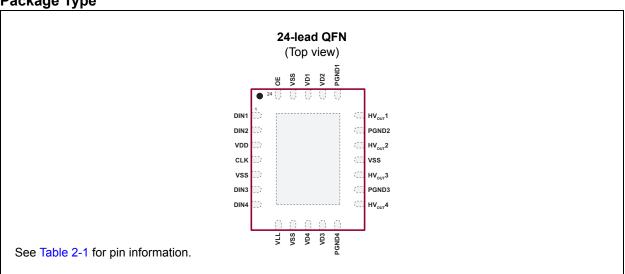
General Description

The CW01 is a 4-channel low-phase-noise continuous wave transmitter IC. A high-speed D flip-flop is provided to allow the D_{IN} frequency to be aligned to a high-frequency clock. The output N-channel is turned on when a logic high is clocked into the D flip-flop. Data are clocked-in during the low-to-high transition.

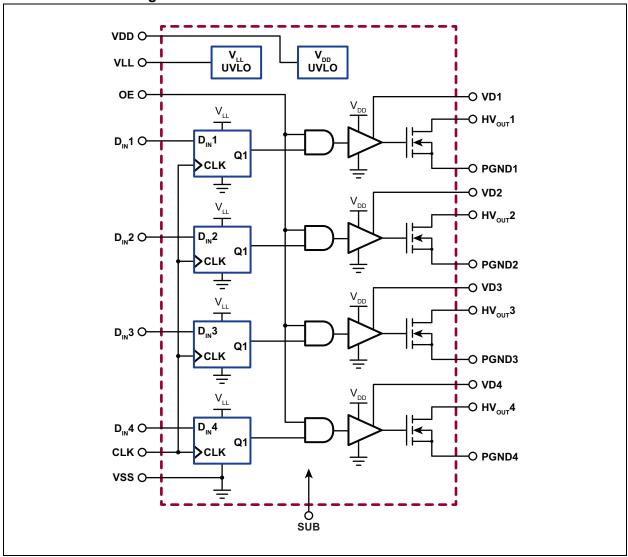
 V_{D1} , V_{D2} , V_{D3} and V_{D4} are four individual input supply voltages for the N-channel output MOSFET gate drivers. High peak currents are drawn from these gate drives when the output MOSFETs are switching. To minimize jitter caused by voltage ripples, each channel has its own gate drive voltage pin—V_{D1}, V_{D2}, V_{D3} and V_{D4}. A series ferrite bead and a decoupling capacitor are recommended on each V_{DX} pin to minimize output jitter and channel-to-channel crosstalk.

Both V_{DD} and V_{LL} have undervoltage lockout to prevent spurious turn-on.

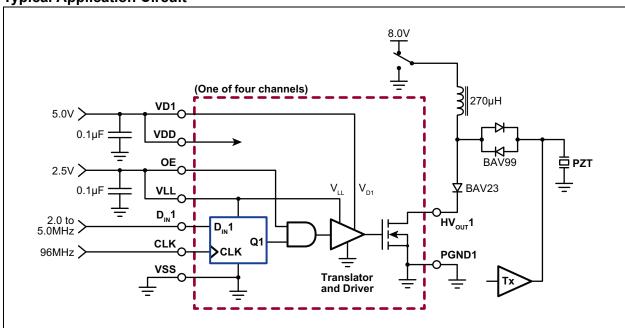
Package Type



Functional Block Diagram



Typical Application Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Logic Supply, V _{LL}	
Level Translator Voltage, V _{DD}	
Gate Drive Voltage, V _{DX}	
High-voltage Output Drain Voltage, HV _{OUT}	
Operating Junction Temperature, T ₁	
Storage Temperature, T _S	–65°C to +150°C
Power Dissipation (T _A = 25°C):	
24-lead QFN	3W

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

Electrical Specifications: $V_{DD} = V_{DX} = 5V$, $V_{LL} = 2.5V$, $T_{J} = 25^{\circ}C$ unless otherwise specified.									
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions			
High-voltage Output	HV _{OUT}	0	_	100	V				
V _{DD} Voltage Range	V_{DD}	4.5	5	5.5	V				
V _{DD} Rise Time	t _{VDD-ON}	50	_	_	μs				
V _{LL} Voltage Range	V_{LL}	1.65	2.5	5.5	V				
V _{LL} Rise Time	t _{VLL-ON}	50	_		μs				
Logic Input Voltage Range	V_{DIN}	0	_	V_{LL}	V				
Gate Drive Voltage	V_{DX}	4.5	5	5.5	V				
V _{DX} Rise Time	t _{VDX-ON}	50	_	_	μs				
V _{DD} Quiescent Current	I_{DDQ}	_	63	100	μΑ				
V _{DD} Average Current	I _{DD}	_	23.5	30	mA	f _{CLK} = 200 MHz, f _{OUT} = 5 MHz, All four channels active			
V _{LL} Quiescent Current	I _{LLQ}	_	8.1	20	μΑ				
V _{LL} Average Current	I _{LL}	_	380	600	μΑ	f _{CLK} = 200 MHz, f _{OUT} = 5 MHz, All four channels active			
V _{DX} Quiescent Current	I _{DXQ}	_	0	1	μΑ				
V _{DX} Average Current	I _{DX}	_	11.3	30	mA	f _{CLK} = 200 MHz, f _{OUT} = 5 MHz, All four channels active			
Input Logic High Voltage	V _{IH}	0.8 V _{LL}	_	V_{LL}	V				
Input Logic Low Voltage	V_{IL}	0	_	0.2 V _{LL}	V				
Input Logic High Current	I _{IH}	_	_	1	μΑ				
Input Logic High Current	I _{IL}	-1	_	_	μΑ				
Output On-resistance	R _{ON}	_	4.7	7	Ω	I _{IN} = 100 mA			
Output Saturation Current	I _{SAT}	_	0.8	_	Α	V _{DD} = HV _{OUT} = 5V			
High-voltage Output Leakage	I _{HVleak}	_	_	10	μΑ	HV _{OUT} = 100V			
UVLO Trip Point for V _{LL}	UVLO_V _{LL}	_	1.5	_	V				
UVLO Trip Point for V _{DD}	UVLO_V _{DD}	_	4	_	V				

AC ELECTRICAL CHARACTERISTICS

Electrical Specifications: $V_{DD} = V_{DX} = 5V$, $V_{LL} = 2.5V$, $T_{J} = 25^{\circ}C$ unless otherwise specified.									
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions			
Clock Frequency	f _{CLK}	0	_	200	MHz				
Clock Rise and Fall Times	t _r , t _f	_	0.5	5	ns				
Set-up Time, D _{IN} to CLK	t _{SU}	2	_	_	ns				
Hold Time, D _{IN} from CLK	t _H	1	_	_	ns				
HV _{OUT} Fall Time	t _{HVf}	_	0.8	_	ns	Load = 50Ω to 8V (See Timing Waveforms .)			
HV _{OUT} Rise Time	t _{HVr}	_	3.3	_	ns	Load = 50Ω to 8V (See Timing Waveforms .)			
Delay Time from CLK to HV _{OUT} from Low to High	t _{dLH}	_	5.1	_	ns	Load = 50Ω to 8V (See Timing Waveforms .)			
Delay Time from CLK to HV _{OUT} from High to Low	t _{dHL}	_	2.6	_	ns	Load = 50Ω to 8V (See Timing Waveforms .)			
Delay Time Matching for t _{dLH}	$\Delta t_{dLHdelay}$	_	0.5	1	ns				
Delay Time Matching for t _{dHL}	$\Delta t_{ m dHLdelay}$	_	0.5	1	ns				
Output Enable Turn-on Time	t _{OE(ON)}	_	_	10	μs				
Output Enable Turn-off Time	t _{OE(OFF)}		_	0.1	μs				
Output Conscitones		_	8	_	pF	At 8V			
Output Capacitance	C _{OUT}	_	4	_	pF	At 100V			
Phase Noise	N _{Phase}	_	-171	-160	dBC/Hz	dB below carrier, CLK = 80 MHz, D _{IN} = 2 MHz, Frequency offset = 1 kHz, Noise bandwidth = 140 Hz (See Figure 3-1 and Figure 3-2.)			

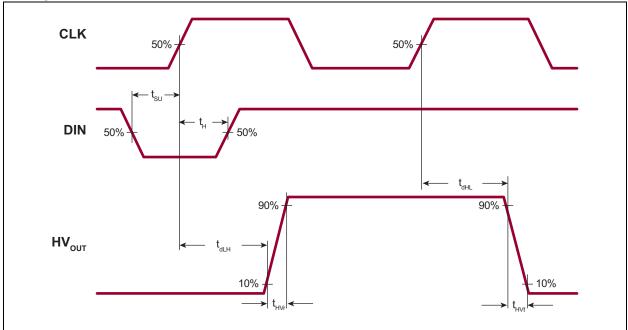
TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions		
TEMPERATURE RANGE								
Operating Junction Temperature	T_J	-4 0	_	+125	°C			
Storage Temperature	T _S	-65	_	+150	°C			
PACKAGE THERMAL RESISTANCE								
24-lead QFN	θ_{JA}	_	26.9	_	°C/W	Note 1		

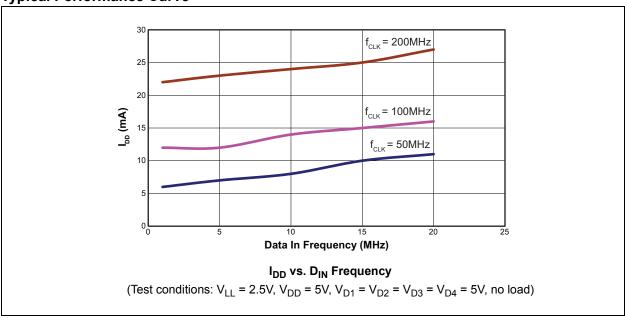
Note 1: Device is mounted on a 4-layer 3" by 4" board.

CW01

Timing Waveforms



Typical Performance Curve



2.0 PIN DESCRIPTION

Table 2-1 shows the description of pins in CW01. Refer to **Package Type** for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description			
1	DIN1	D flip-flop logic input for HVOUT1. Logic high will turn on output N-channel.			
2	DIN2	D flip-flop logic input for HVOUT2. Logic high will turn on output N-channel.			
3	VDD	Level translator supply. Should be at the same potential as VDX.			
4	CLK	Logic clock input			
5	VSS	Ground. Should be externally shorted to all PGND and VSS pins.			
6	DIN3	D flip-flop logic input for HVOUT3. Logic high will turn on output N-channel.			
7	DIN4	D flip-flop logic input for HVOUT4. Logic high will turn on output N-channel.			
8	VLL	Logic input supply voltage			
9	VSS	Ground. Should be externally shorted to all PGND and VSS pins.			
10	VD4	Gate drive supply voltage for HVOUT4. Should be at the same potential as VDD.			
11	VD3	Gate drive supply voltage for HVOUT3. Should be at the same potential as VDD.			
12	PGND4	Power ground for HVOUT4. Should be externally shorted to all PGND and VSS pins.			
13	HVOUT4	Drain output for HVOUT4			
14	PGND3	Power ground for HVOUT3. Should be externally shorted to all PGND and VSS pins.			
15	HVOUT3	Drain output for HVOUT3			
16	VSS	Ground. Should be externally shorted to all PGND and VSS pins.			
17	HVOUT2	Drain output for HVOUT2			
18	PGND2	Power ground for HVOUT2. Should be externally shorted to all PGND and VSS pins.			
19	HVOUT1	Drain output for HVOUT1			
20	PGND1	Power ground for HVOUT1. Should be externally shorted to all PGND and VSS pins.			
21	VD2	Gate drive supply voltage for HVOUT2. Should be at the same potential as VDD.			
22	VD1	Gate drive supply voltage for HVOUT1. Should be at the same potential as VDD.			
23	VSS	Ground. Should be externally shorted to all PGND and VSS pins.			
24	OE	Output enable logic input. Logic low will turn off all HVOUT.			
Cent	er Pad	Should be externally shorted to all PGND and VSS pins.			

3.0 FUNCTIONAL DESCRIPTION

Figure 3-1 and Figure 3-2 illustrate the test circuits for CW01.

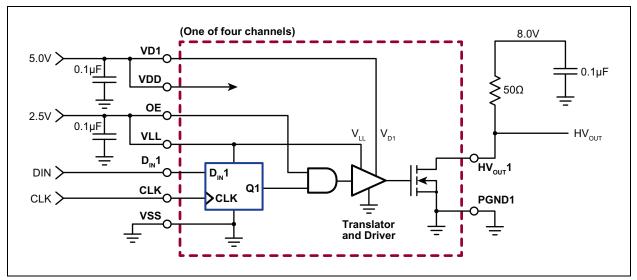


FIGURE 3-1: AC Timing.

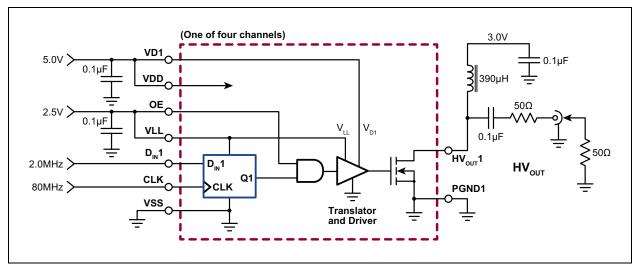


FIGURE 3-2: Phase Noise.

4.0 PACKAGING INFORMATION

4.1 Package Marking Information

24-lead QFN

XXXXX XX@YY WWNNN Example

CW01 K6 ¹ 17 25529

Legend: XX...X Product Code or Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

e3 Pb-free JEDEC® designator for Matte Tin (Sn)

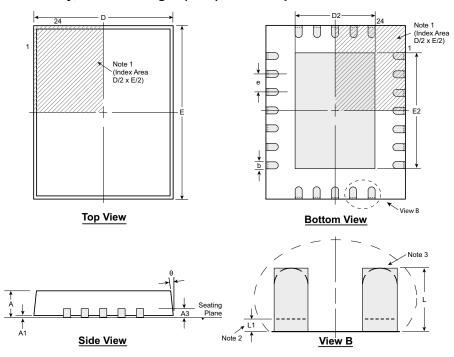
This package is Pb-free. The Pb-free JEDEC designator (e3)

can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

24-Lead QFN Package Outline (K6)

4.00x5.00mm body, 1.00mm height (max), 0.50mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging. Notes:

- A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
- Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present. The inner tip of the lead may be either rounded or square.

Symb	ol	Α	A1	А3	b	D	D2	E	E2	е	L	L1	θ
	MIN	0.80	0.00		0.18	3.85*	2.50	4.85*	3.50		<i>†</i> 0.30	0.00	0°
Dimension (mm)	NOM	0.90	0.02	0.20 REF	0.25	4.00	2.65	5.00	3.65	0.50 BSC	0.40	-	-
()	MAX	1.00	0.05		0.30	4.15*	2.80	5.15*	3.80		<i>†</i> 0.50	0.15	14°

JEDEC Registration MO-220, Variation VGHD-1, Issue K, June 2006 * This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

APPENDIX A: REVISION HISTORY

Revision A (July 2017)

- Converted Supertex Doc# DSFP-CW01 to Microchip DS20005810A
- · Changed the package marking format
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u>. xx</u>		- <u>x</u> - <u>x</u>	Example:	
Device	Packaç Option		Environmental Media Type	a) CW01K6-G:	Four-Channel Low-Phase-Noise Low-Power Continuous Wave Transmitter, 24-lead QFN, 3000/Reel
Device:	CW01	=	Four-Channel Low-Phase-Noise Low-Power Continuous Wave Transmitter		
Package:	K6	=	24-lead QFN		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	3000/Reel for a K6 Package		

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